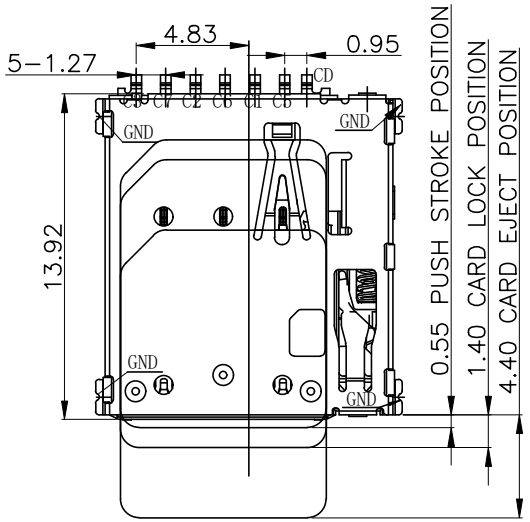
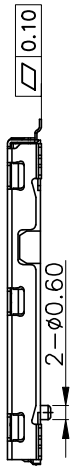
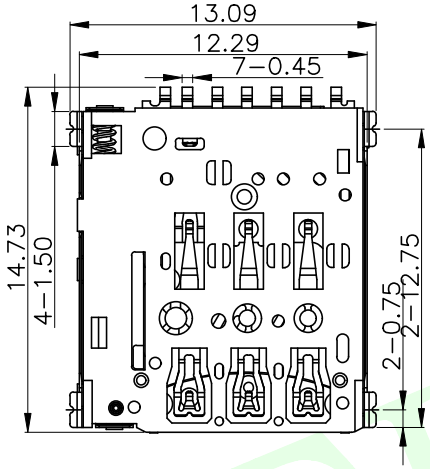
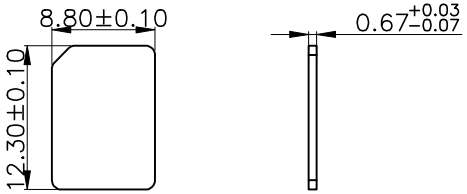
RoHS Compliant

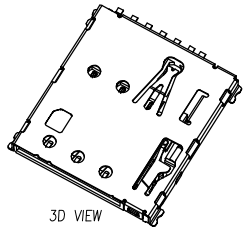




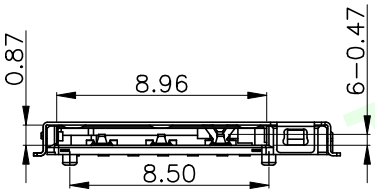


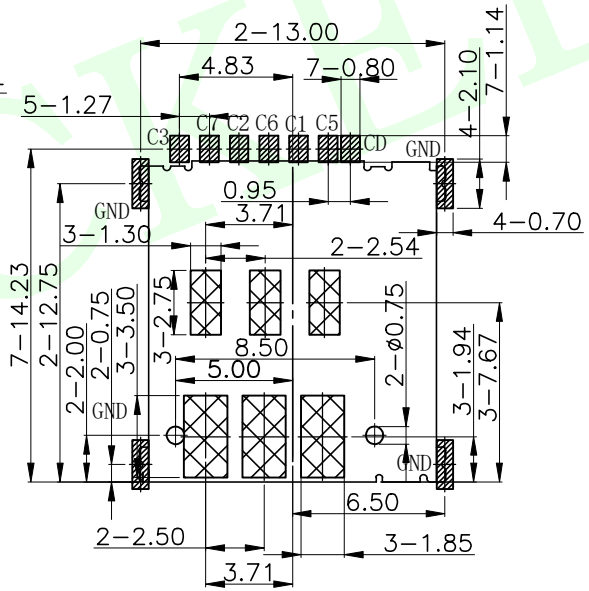


卡片尺寸
2:1



Notes:
1.Material:
Housing: High Temperature Thermoplastic
Terminal:Copper Alloy
Shell: Stainless Steel
2.Plating:
Terminal:50u" Ni Underplated Overall
G/F Plated On Contact Area
G/F Plated On Solder Area
Sheel:30u" Ni Underplated Overall
G/F Plated On Contact Area And Solder Area
3.Technical Speciality:
Rated Voltage: 30V
Current Rating: 0.5A
Insulation Resistance:1000MΩ Min.
Contact Resistance:100mΩ Max.
Withstanding Voltage: 500V DC For 1 Minutes.
Operating Temperature: −40℃~+75℃ Humidity 80% R.H Max.





LCK−NANO−113B P7 H137−Y L G

连晟欣
LCK

产品类别
MS:MINI SIM
SIM:MICRO SIM
NANO: NANO SIM

产品流水料号识别码

产品PIN位
P7: 7PIN

产品高度
H150: 1.50MM

有柱无柱
Y: 有柱
W: 无柱

包装方式
L: 圆盘

电镀规格
G: gold flash
G1: 1U
G3: 3U
(以此推类)

PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O

RECOMMENDED PCB LAYOUT

TOLERANCE: ±0.05

SMT SOLDER AREA

COPPER RESTRICTED AREA
1. TOUCH AREA OF CONTACT TIPS NO ELECTRICAL FUNCTION
2. NO FIRST PCB_LAYOUT CIRCUITS IN THE AREA

MEASURE POINT:
QUADRANT POINT (QP)
TANGERCY POINT (TP)
INTERSECTION POINT (IP)

UNLESS OTHERWISE SPECIFIED,TOLERANCE:

X.	±0.25
X.x	±0.20
X.xx	±0.15
ANGULAR	±3°

联晟欣连接器（深圳）有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

DESIGN	Andy	DATE	2014.12.24	TITLE: 1.37H NANO SIM CARD CONNECTOR 防飞自锁结构
CHECKED		DATE		
APPROVED		DATE		
PART NO: LCK−NANO−113B−P7H137−YLG		REV: 04	SCALE: 1:1	UNIT: mm
DRAWING NO:		SIZE: A4	SHEET: 1/1	

LCKELEC